PRODUCT   SPECIFICATION

CS0802C-D-BSXTSWN-101

V1.0

March 3, 2008

Easterntronic LCD Group

REVISION RECORD

REV	DESCRIPTION	DATE
V1.0	Frist Issue	March 3, 2008

CONTENTS

1. TYPE   NUMBER   AND   DESCRIPTION

Type   Number   :   CS0802C-D-BSXTSWN-101

Description   :   8 Characters X 2 lines

LCD   Panel   :   Blue STN, Negative, Transmissive

Viewing angle   :   6H

Duty and Bias   :   1/16 duty, 1/5 bias

Logic   Voltage   :   5.0V

Operating   Temperature :   -20˚C−70˚C

Storage   Temperature   :   -30˚C−80˚C

Controller   :   ST7066U-OA or equivalent

IC package   :   Bonding

BackLight Type   :   Side, White LED

2. LCD MODULE NUMBERING SYSTEM

LCD MODULE NUMBERING SYSTEM

✳ ✳ ✳ , , ✳ ✳ — ✳ — ✳ ✳ ✳ ✳ ✳ ✳ ✳ — ✳ ✳

SERIES NUMBER(FROM 00-99)

1 : RoHS Compliance
0/Null : RoHS Incompliance

NEGATIVE POWER ON BOARD :
W: WITH NEGATIVE POWER
N: NO NEGATIVE

BACKLIGHT COLOR :
N: NO BACKLIGHT Y: YELLOW-GREEN
G: GREEN   B: BLUE
R: RED   A: AMBER
W: WHITE   M: MULTICOLOR

BACKLIGHT STYE :
N: NO   E: EL   C: CCFL
D: LED (BOTTOM)   S: LED(SIDE)

POLARIZER TYPE :
R: REFLECTIVE   T: TRANSMISSIVE F: TRANSFLECTIVE

TEMPERATURE RANGE:
N: 0°C-50°C   X: -20°C-70°C   E: -30°C-80°C

VIEW DIRECTION :
S: 6:00   T: 12:00   O: OTHER

LCD TYPE :
P: POS TN   N: NEG TN   H: HTN
Y: YELLOW STN   G: GREY STN   B: BLUE STN
F: FSTN

IC (MASTER) PACKAGE:
Q: QFP   D: CHIP   G: COG   T: TCP   F: COF   N: WHITOUT IC

LCD VERSION (FROM A,B...)

DISPLAY CONTENT :
CHARACTERS X LINES / ROWS X COLUMNS / OTHER

USEDER :
S: STANDARD MODULE   C: CUSTOM DESIGN MODULE

DISPLAY TYPE :
G: GRAPHIC   S: SEGMENT   C: CHARACTER

3. MECHANICAL SPECIFICATIONS:

ITEM	STANDARD VALUE	UNIT
NUMBER OF CHARACTERS	8 CHARACTERS X 2 LINES	
CHARACTER FORMAT	5 X 7 DOTS with CURSOR	
MODULE DIMENSION	40.0(W) X 35.5(H) X 12.5(T)	mm
EFFECTTVE DISPLAY AREA	30.0(W) X 14.0(H)	mm
CHARACTER SIZE	2.70(W) X 4.35(H)	mm
CHARACTER PITCH	3.10W) X 4.75(H)	mm
DOT SIZE	0.50(W) X 0.50(H)	mm
DOT PITCH	0.55(W) X 0.55(H)	mm
APPROX WEIGHT	50	g
LCD TYPE	Blue STN, Negative, Transmissive	
DUTY AND BIAS	1/16 DUTY; 1/5 BIAS	
VIEWING DIRECTION	6:00	
BACK LIGHT	Side, White LED	
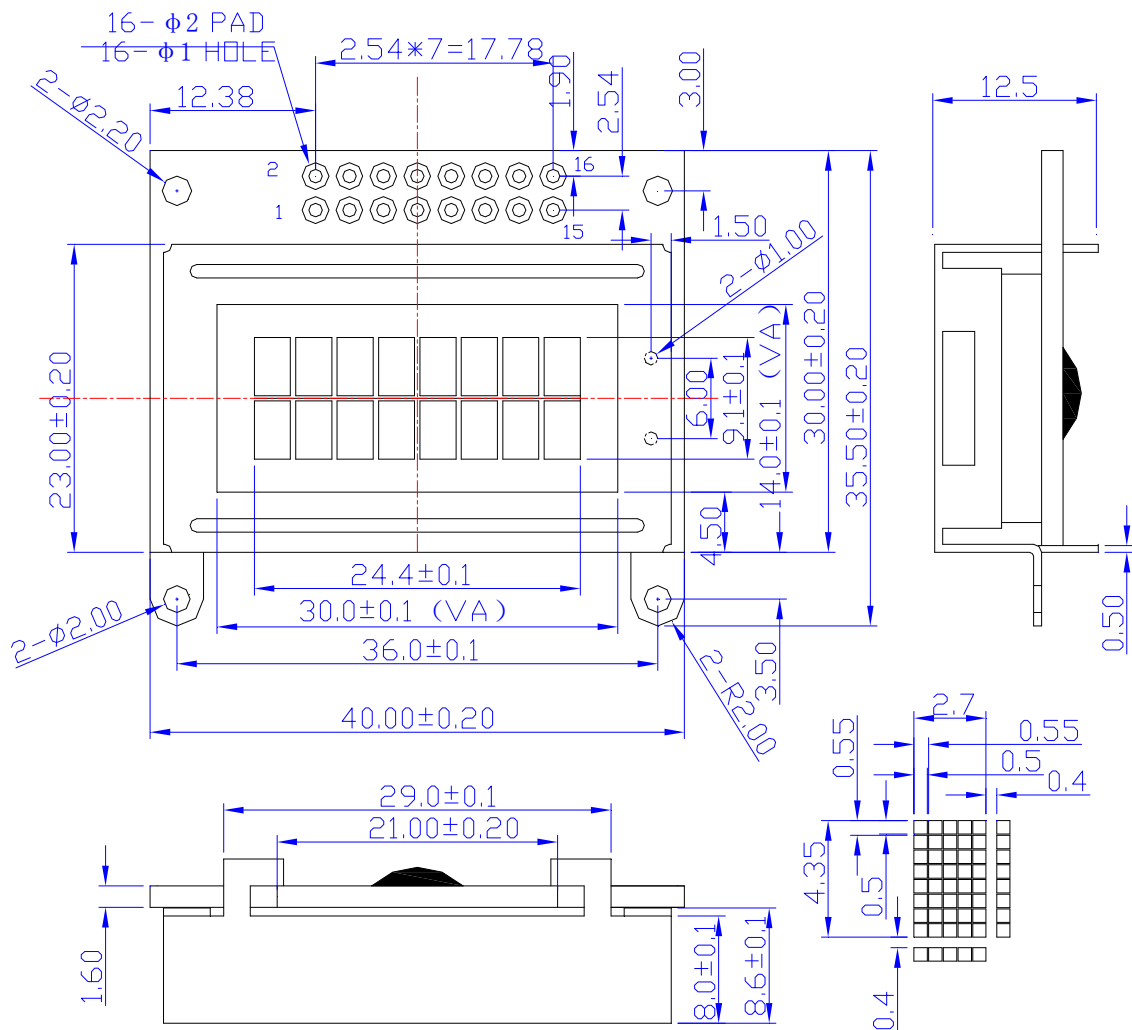
4. ELECTRICAL   BLOCK   DIAGRAM

4.1 PINS DEFINITION

PIN	SYMBOL	FUNCTION
1	Vss	Power Supply(GND)
2	Vdd	Power Supply(+5V)
3	Vo	Contrast Adjust
4	RS	Instruction/Data Register Select
5	R/W	Data Bus Line
6	E	Enable Signal
7-14	DB0-DB7	Data Bus Line
15	A	Power Supply For LED Backlight(+)
16	K	Power Supply For LED Backlight(-)

4.2 ELECTRICAL BLOCK DIAGRAM
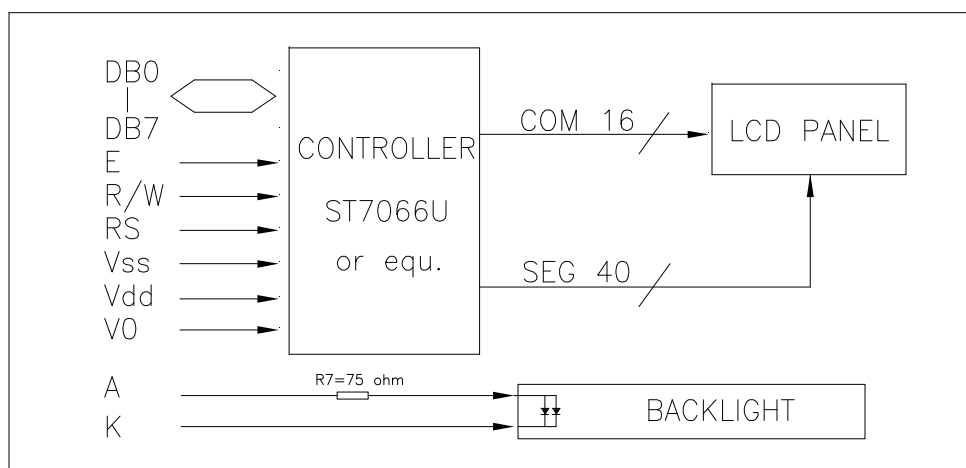
4.3 DISPLAY CHARACTER ADDRESS CODE

DISPLAY POSITION		1	2	3	4	5	6	7	8
DDRAM ADDRESS	LINE1	00	01	02	03	04	05	06	07
	LINE2	40	41	42	43	44	45	46	47

5. ABSOLUTE MAXIMUM RATINGS

5.1 Electrical Maximum Ratings   (Ta=25deg C)

ITEM	SYMBOL	CONDITION	MIN	MAX	UNIT
Supply Voltage (Logic)	Vdd – Vss	-	0	7.0	V
Supply Voltage (LCD Drive)	Vdd – V0	-	0	11.5	V
Input Voltage	Vi	-	-0.3	Vdd +0.3	V

5.2 Environmental Conditions

ITEM	SYMBOL	CONDITION	MIN	MAX	UNIT
Operating Temp	Topr	-	-20	70	deg C
Storage Temp	Ttsg	-	-30	80	deg C
Humidity Endurance	RH	no condensation Ta</=40 deg	-	95	%
Vibration	-	3 directions	see note (a)		-
Shock	-	3 directions	see note (b)		-

note (a):   frequency :   varying from 10 Hz in a 1-minute cycle

amplitude :   1.5mm

duration   :   120 cycles, each lasting 1 minute,

for each of the 3 directions, x,y,z

note (b):   nutually perpendicular directions

direction normal to surface of LCD glass

80G, half-sine pulse of duration 11ms

other 2 directions

100G, half-sine pulse of duration 11ms

6. ELECTRICAL SPECIFICATIONS

6.1 Electrical Characteristics at Ta=25 deg C, Vdd = 5V + / - 5%

ITEM	SYMBOL	CONDITION	MIN	TYP	MAX	UNIT
Supply Voltage (logic)	Vdd-Vss	-	4.5	5.0	5.5	V
Supply Voltage (LCD)	Vdd-V0	Vdd = 5V	4.6	4.8	5.0	V
Input signal voltage (for E, DB0-7,R/W,RS)	V-ih	"H" level	0.7 Vdd	-	Vdd	V
	V-il	"L" level	0	-	0.6	V
Supply Current (logic)	Icc	-	0.9	1	1.2	mA
Supply Current (LCD)	Io	-	0.15	0.22	0.27	mA
Supply Voltage (LED)	V-bl	-	2.9	3.1	3.3	V
Supply Current(LED)	I-bl	-	-	30	40	mA

6.2 Timing Specifications at Ta = 25 deg C, Vdd = 5V+/-10%, Vss =0V
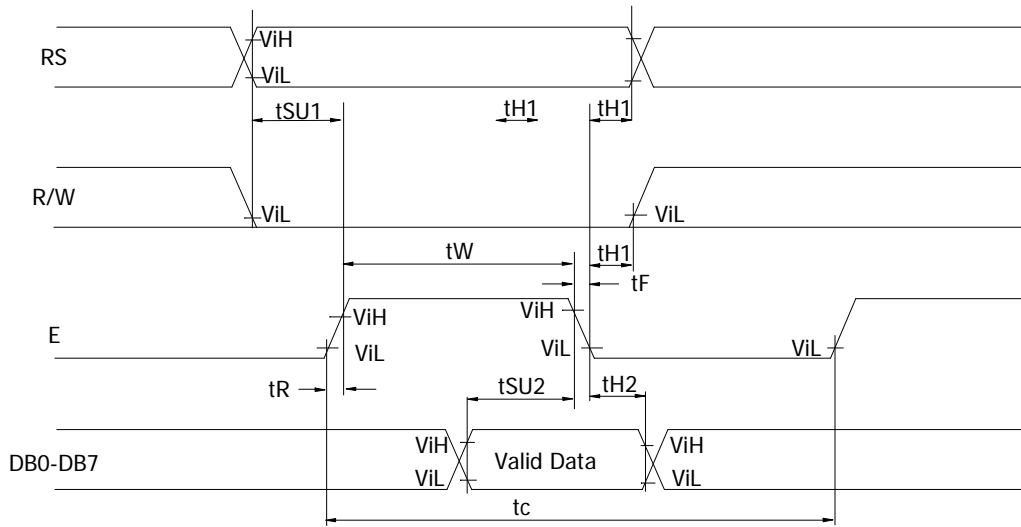
6.2.1 Write mode

ITEM	SYMBOL	MIN	MAX	UNIT
E cycle time	tc	1200	-	ns
E rise time	tR	-	25	ns
E fall time	tF	-	25	ns
E-pulse width (H, L)	tw	140	-	ns
R/W and RS set-up time	tsul	0	-	ns
R/W and RS hold time	tH1	10	-	ns
Data set-up time	tsu2	40	-	ns
Data hold time	tH2	10	-	ns

6.2.2 Read mode

ITEM	SYMBOL	MIN	MAX	UNIT
E cycle time	tc	1200	-	ns
E rise time	tR	-	25	ns
E fall time	tF	-	25	ns
E-pulse width (H, L)	tw	140	-	ns
R/W and RS set-up time	tsu	0	-	ns
R/W and RS hold time	tH	10	-	ns
Data output delay	tD	-	120	ns
Data hold time	tDH	20	-	ns

6.2.3 Timing Diagram

WRITE MODE TIMING DIAGRAM

RS

tSU1   tH1   tH1

R/W   ViL   ViL

tW   tH1

tF

E   ViH   ViH

ViL   ViL   ViL

tR   tSU2   tH2

DB0-DB7   ViH   Valid Data   ViH

ViL   ViL

tc

READ MODE TIMING DIAGRAM

RS   ViH   ViL

tSU   tH1   tH

R/W   ViH   ViH

tW   tH

tF

E   ViH   ViH

ViL   ViL   ViL

tR   tD   tDH

DB0-DB7   ViH   Valid Data   ViH

ViL   ViL

tc
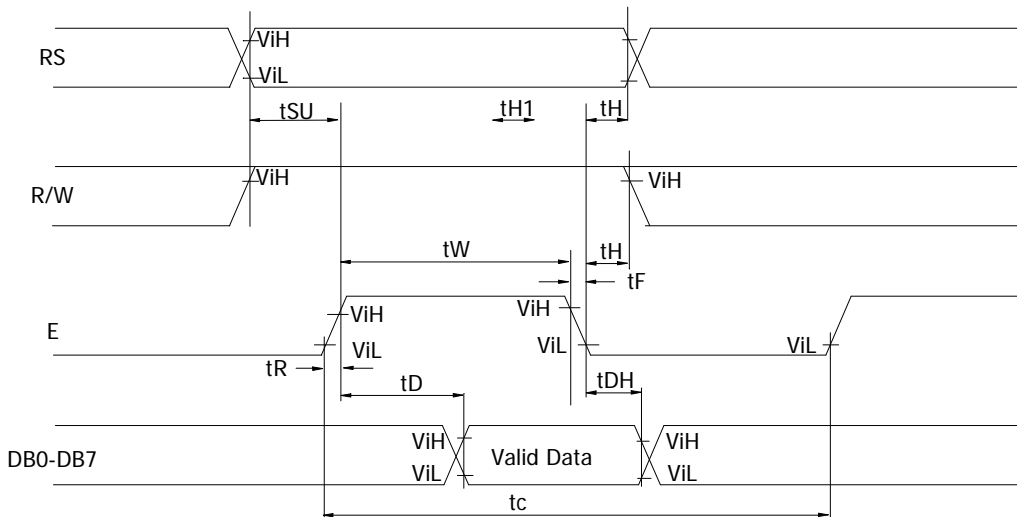
7. POWER SUPPLY FOR LCD MODULE

LCD
MODULE

Vdd   + 5 V

Vdd-V0

V0   VR   Vdd

Vss   GND
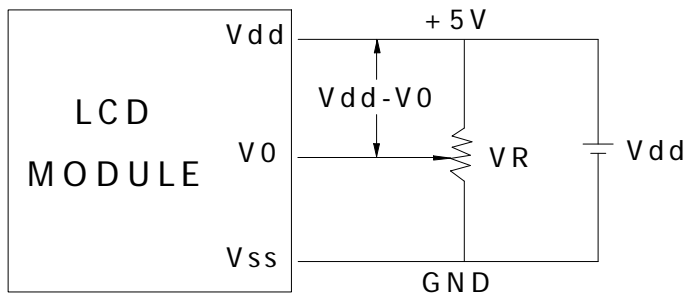
Vdd-V0: LCD Driving Voltage
VR: 10K - 20K

8. ELECTRO-OPTICAL CHARACTERISTIC

ITEM	SYMBOL	CONDITION	MIN.	TYP.	MAX.	UNIT	REF.
Contrast	CR	25℃	--	10	--		Note1
Rise Time	tr	25℃	--	160	240	ms	Note2
Fall Time	tf	25℃	--	100	150	ms	note 2
Viewing Angle	θ1-θ2	25℃	--	--	60	DEG	Note 3
	Ø1, Ø2		-40	--	40		
Frame Frequency	Ff	25℃	--	64	--	Hz	note 2

Note(1): Contrast ratio is defined under the following condition:

CR= brightness of selected condition
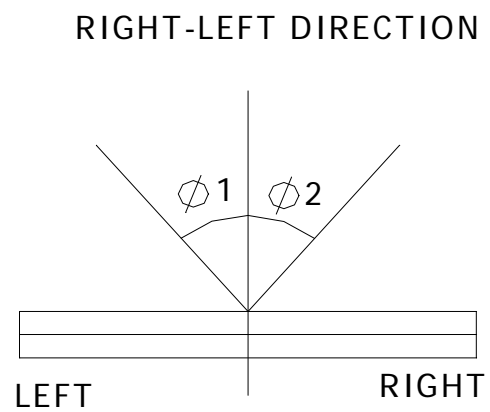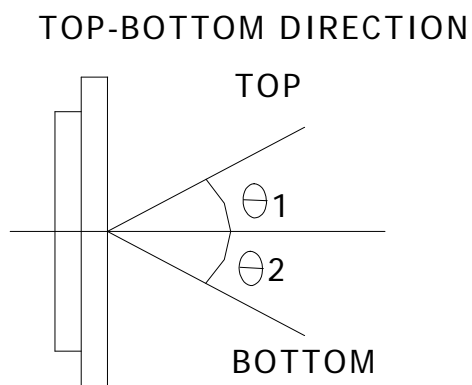
brightness of non-selected condition

(a).   Temperature------------25C

(b).   Frame Frequency------64Hz

(c).   Viewing angle----------θ=0, Ø=0

(d).   Operating Voltage---4.8V

Note(2): definition of response time:
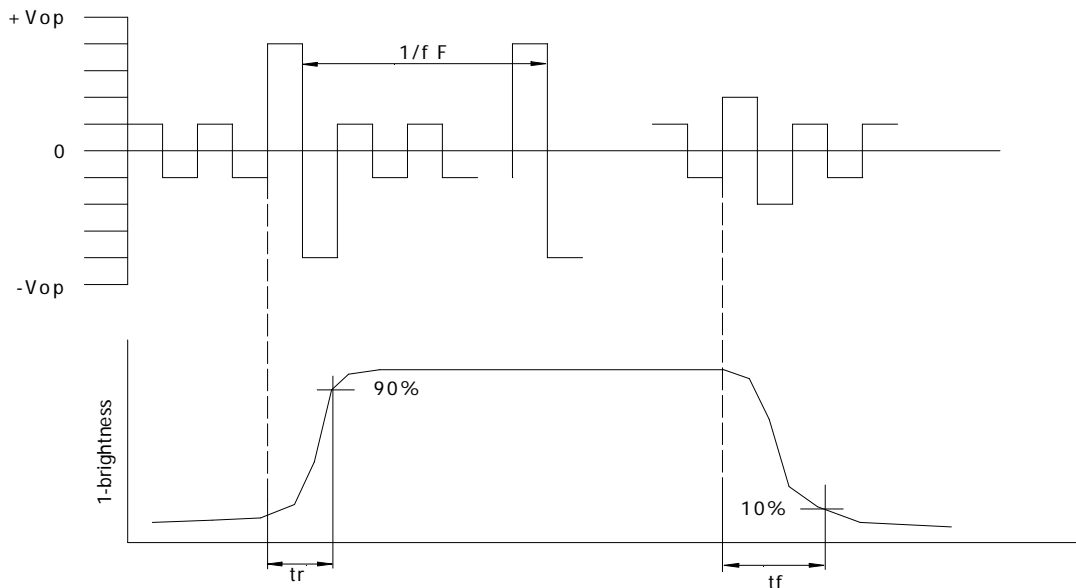
Condition:

(a). Temperature------------25C

(b). Frame Frequency------64Hz

(c). Viewing angle----------$\theta=0, \emptyset=0$

(d). Operating Voltage---4.8V

Note(3): definition of view angle:

TOP-BOTTOM DIRECTION   RIGHT-LEFT DIRECTION

9. INSTRUCTION TABLE

Function	RS	RW	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Description	Execu Time* (Max)
Clear Display	0	0	0	0	0	0	0	0	0	1	Clears entire display and returns the cursor to home position (address 0)	1.64mS
Return Home	0	0	0	0	0	0	0	0	1	X	Return the cursor to the home position. DD RAM contents remain unchanged. Set DD RAM address to zero.	1.64mS
Entry mode set	0	0	0	0	0	0	0	1	1/D	S	Set cursor moving direction and enable the shift of the display. These operations are performed during data write/read of DD RAM/CG RAM. 1/D=1: increment; 1/D=0: decrement; S=1: whole display shift when data is written.	40μS
Display ON/OFF control	0	0	0	0	0	0	1	D	C	B	Set display (D), cursor(C) and blinking of cursor(B) ON/OFF. D=1: display ON; D=0: display OFF. C=1: Cursor ON; C=0: cursor OFF. B=1: Blink ON; B=0, Blink OFF.	40μS
Cursor or Display shift	0	0	0	0	0	1	S/C	R/L	X	X	Move the cursor and shift the display without changing DDRAM contents. S/C=1: Display Shift; S/C=0:Cursor move. R/L=1:shift to right; R/L=0:shift to left.	40μS
Function Set	0	0	0	0	1	DL	N	F	X	X	Set interface data length (DL), number of display lines (N) and character font (F).DL=1: 8 bits; DL=0: 4 bits. N=1: 2 lines; N=0: 1 lines. F=1: 5X11 dots; F=0: 5X7 dots.	40μS
Set CG RAM add	0	0	0	1	ACG						Set CG RAM address. CG RAM data is sent and received after this setting.	40μS
Set DD RAM Add	0	0	1	ADD							Set DD RAM address. DD RAM data is sent and received after this setting.	40μS
Read BF & Addr	0	1	BF	AC							Read BUSY FLAG (BF) and the contents of the address counter. BF=1: internal operation; BF=0: can accept instruction.	0μS
Write Data to RAM	1	0	WRITE DATA								Write data into DDRAM or CGRAM.	40μS**
Read Data from RAM	1	0	READ DATA								Read data from DDRAM or CGRAM.	40μS**

10. INITIALIZATION BY INSTRUCTION

<table>
<tr><td align="center">

8-bits

</td><td align="center">

4–bits

</td></tr>
<tr><td align="center">

Power On

⬇

Wait for more than 15 ms

after Vdd rises to 4.5V

⬇

RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
0	0	0	0	1	1	X	X	X	X

Function set: interface is 8 bit long

⬇

Wait for more than 4.1 Ms

⬇

RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
0	0	0	0	1	1	X	X	X	X

Function set

⬇

Wait for more than 0.1 Ms

⬇

RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
0	0	0	0	1	1	X	X	X	X

Function set

⬇

RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
0	0	0	0	1	1	X	X	X	X

Function set: DL=1,8 bit interface data

⬇

RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
0	0	0	0	0	0	1	0	0	0

Display Off

⬇

RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
0	0	0	0	0	0	0	0	0	1

Clear all display and return cursor to home position

⬇

RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
0	0	0	0	0	0	0	1	I/D	S

Entry mode set

END OF INITIALIZATION

</td><td align="center">

Power On

⬇

Wait for more than 15 mS

after Vdd rises to 4.5V

⬇

RS	R/W	DB7	DB6	DB5	DB4
0	0	0	0	1	1

Function set: DL=1,8 bit interface data.

⬇

Wait for more than 4.1 Ms

⬇

RS	R/W	DB7	DB6	DB5	DB4
0	0	0	0	1	1

DL=1,8 bit interface data

⬇

Wait for more than 0.1 Ms

⬇

RS	R/W	DB7	DB6	DB5	DB4
0	0	0	0	1	0

DL=0,4 bit interface data

⬇

RS	R/W	DB7	DB6	DB5	DB4
0	0	0	0	1	0
0	0	N	F	X	X

Function set: DL=0,4 bit interface data

⬇

RS	R/W	DB7	DB6	DB5	DB4
0	0	0	0	0	0
0	0	1	0	0	0

Display Off

⬇

RS	R/W	DB7	DB6	DB5	DB4
0	0	0	0	0	0
0	0	0	0	0	1

Function set: DL=0,4 bit interface data

⬇

RS	R/W	DB7	DB6	DB5	DB4
0	0	0	0	0	0
0	0	0	1	I/D	S

Entry mode set

END OF INITIALIZATION

</td></tr>
</table>

11. SOFTWARE EXAMPLES

8-BIT OPERATION   8 characters X 2 lines

Function	RS RW D7 D6 D5 D4 D3 D2 D1 D0	DISPLAY	DESCRIPTION
Power on delay			Initialization. No display appears.
Function set	0 0 0 0 1 1 0 0 X X	-------------- --------------	Sets 8-bit operation, 2-line display and 5*7 dots character font.
Display OFF	0 0 0 0 0 0 1 0 0 0		Turn off display.
Display ON	0 0 0 0 0 0 1 1 1 0		Turn on display and cursor.
Entry Mode set	0 0 0 0 0 0 0 1 1 0	-------------- --------------	Set mode to increment the address by one and to shift the cursor to the right, at the time of write to the DD/CG RAM. Display is not shifted.
Write data to CG/DD RAM	1 0 0 1 0 0 1 1 1 1	O_____ --------------	Write "O". Cursor incremented by one and shift to right.
Write data to CG/DD RAM	1 0 0 1 0 1 0 0 1 0	OR_____ --------------	Write "R". Cursor incremented by one and shift to right
Write data to CG/DD RAM	. . . . . .	ORIENT_____ --------------	Write "I" "E" "N" "T".
Set DDRAM address	0 0 1 1 0 0 0 0 0 0	ORIENT_____ --_-----------	Set RAM address so that the cursor is positioned at the head of the Second line
Write data to CG/DD RAM	. . . . . .	ORIENT_____ DS_____	Write "D" "S".
Cursor or display shift	0 0 0 0 0 1 0 0 X X	ORIENT_____ DS_____	Shift only the cursor position to the left.
Write data to CG/DD RAM	. . . . . .	ORIENT_____ DISPLAY_____	Write "I" "S" "P" "L" "A" "Y"

4-bit operation (4-bits 1 line)

Function	RS RW D7 D6 D5 D4	Display	Description
power on delay			Initialization. No display appears.
Function set	0 0 0 0 1 0		Sets to 4 -bit operation. In this case, operation is handled as 8-bits by initialization, and Only this instruction completes with one write.
Function set	0 0 0 0 1 0 0 0 0 0 X X		Sets 4 -bit operation, 1-line display and 5*7 dot character font. (number of display lines and character fonts can not be changed hence after.)
Display ON/OFF Control	0 0 0 0 0 0 0 0 1 1 1 0	_	Turn on display and cursor.
Entry Mode Set	0 0 0 0 0 0 0 0 0 1 1 0	_	Turn on display and cursor.
Write data to CG/DD/ARM	1 0 0 1 0 0 1 0 1 1 1 1		Write "O". Cursor incremented by one and shift to right.
same as 8-bit operation			

12. Standard character pattern

13. RECAUTION FOR USING LCM

1. LIQUID CRYSTAL DISPLAY (LCD)

LCD is made up of glass, organic sealant, organic fluid, and polymer based polarizers. The following precautions should be taken when handing,

(1). Keep the temperature within range of use and storage. Excessive temperature and humidity could cause polarization degredation, polarizer peel off or bubble.

(2). Do not contact the exposed polarizers with anything harder than an HB pencil lead. To clean dust off the display surface. Wipe gently with cotton. Chamois or other soft material soaked in petroleum benzin.

(3). Wipe off saliva or water drops immediately. Contact with water over a long period of time may cause polarizer deformation or color fading, while an active LCD with water condensation on its surface will cause corrosion of ITO electrodes.

(4). Glass can be easily chipped or cracked from rough handing. especially at corners and edges.

(5). Do not drive LCD with DC voltage.

2. Liquid Crystal Display Modules

2.1 Mechanical Considerations

LCM are assembled and adjusted with a high degree of precision. Avoid excessive shocks and do not make any alterations or modifications. The following should be noted.

(1). Do not tamper in any way with the tabs on the tabs on the metal frame.

(2). Do not modify the PCB by drilling extra holes, changing its outline, moving its components or modifying its pattem.

(3). Do not touch the elastomer connector, especially insert an backlight panel (for example, EL).

(4). When mounting a LCM make sure that the PCB is not under any tress such as bending or twisting. Elastomer contacts are very delicate and missing pixels could result from slight dislocation of any of the elements.

(5). Avoid pressing on the metal bezel, otherwise the elastomer connector could be deformed and lose contact, resulting in missing piels.

2.2. Static Electricity

LCM contains CMOS LSI's and the same precaution for such devices should apply, namely

(1). The operator should be grounded whenever he/she comes into contact with the module. Never touch any of the conductive parts such as the LSI pads, the copper leads on the PCB and the interface terminals with any parts of the human body.

(2). The modules should be kept in antistatic bags or other containers resistant to static for storage.

(3). Only properly grounded soldering irons should be used.

(4). If an electric screwdriver is used, it should be well grounded and shielded from commutator sparks.

(5). The normal static prevention measures should be observed for work clothes and working benches; for the latter conductive (rubber) mat is recommended.

(6). Since dry air is inductive to statics, a relative humidity of 50-60% is recommended.

2.3. Soldering

(1). Solder only to the I/O terminals.

(2). Use only soldering irons with proper grounding and no leakage.

(3). Soldering temperature: 280 ℃±10℃

(4). Soldering time: 3 to 4 sec.

(5). Use eutectic solder with resin flux fill.

(6). If flux is used, the LCD surface should be covered to avoid flux spatters. Flux residue should be removed after wards.

2.4. Operation

(1). The viewing angle can be adjusted by varying the LCD driving voltage V0.

(2). Driving voltage should be kept within specified range; excess voltage shortens display life.

(3). Response time increases with decrease in temperature.

(4). Display may turn black or dark blue at temperatures above its operational range; this is (however not pressing on the viewing area) may cause the segments to appear "fractured".

(5). Mechanical disturbance during operation (such as pressing on the viewing area) nay cause the segments to appear "fractured".

2.5. Storage

If any fluid leaks out of a damaged glass cell, wash off any human part that comes into contact with soap and water. Never swallow the fluid. The toxicity is extremely low but caution should be exercised at all the time.

2.6. Limited Warranty

Unless otherwise agreed between EASTERNTRONIC and customer, EASTERNTRONIC will replace or repair any of its LCD and LC, which is found to be defective electrically and visually when inspected in accordance with EASTERNTRONIC acceptance standards, for a period on one year from data of shipment. Confirmation of such date shall be based on freight documents. The warranty liability of EASTERNTRONIC is limited to repair and/or replacement on the terms set forth above. EASTERNTRONIC will not responsible for any subsequent or consequential events.

14. Declaration of conformity regarding the limitation of dangerous substances

深圳易事通液晶显示模块有限公司

SHENZHEN EASTERNTRONIC LCM CO ., LTD.

4F , B3 Building , FuYuan Industrial Zone , FuYong Town,

BaoAn District,ShenZhen,P.R.China

DECLARATION OF CONFORMITY REGARDING THE LIMITATION OF DANGEROUS SUBSTANCES

WE , SHENZHEN EASTERNTRONIC LCM CO ., LTD,
Declare that the product of CS0802C-D-BSXTSWN-101 complies with:
The directive 2002/95/EC Dated 2003/01/27 regarding the limitation of dangerous substances, in particular to clause 4 which forbids the use of the following elements:
●Lead
●Mercury
●Cadmium
●Hexavalant chromium
●Polybrominated biphenyls
●Polybrominated diphenylethers
And to the annex which points out the exempted implementations
□ To the directive 73/23/eec dated 1973/02/19 and the standard EN60335-1 regarding prohibition of following elements:
　　● Oils containing polychlorinated biphenyl
　　● Asbestos
　　● Radioactive substances
Name: Ewing Lau /
　　 SHENZHEN EASTERNTRONIC LCM CO ., LTD.
Issued on March 3, 2008
According with the proposal of Technical Adaption Committee(TAC) of a limit of 0.1% by weight for lead hexavalent chromium, mercury,PBBs and PBDRs and 0.01% by weight for Cadmium.